

RADIATION TEST REPORT

Heavy Ions Testing of

AD584

Voltage Reference

from Analog Devices

ESA Purchase Order No 171720 dated 22/07/97

European Space Agency Contract Report

The work described in this report was done under ESA contract. Responsibility for the contents resides in the author or organization that prepared it

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1. <u>INTRODUCTION</u>

This report presents the results of a heavy ion Single Event Effects (SEEs) test program carried out for the XMM project on Analog Devices AD584 Voltage Reference. Flight lot devices were tested at the European Heavy Ion Irradiation Facility (HIF) at Cyclone, Université Catholique de Louvain, Belgium.

The main aims of these tests were to assess the AD584's susceptibility to Single Event Upsets (SEUs) and Single Event Latch-ups (SELs) by heavy ion. Tests were performed in such a way that the SEU cross sections can be plotted over a wide LET range in order to allow computation of the SEU rates in XMM orbit.

This work was performed for ESA/ESTEC under P.O. No 171720 dated 20/07/97.

2. APPLICABLE DOCUMENTS

The following documents are applicable:

XMM SOW QCA/RHS-XMM.DOC July 97 (fax dated 11 July, 97),

Test Set-up Specification for heavy ion testing of XMM devices
 Hirex Doc No HRX/97.2598 Issue 1 Rev. A dated 7 August 1997 -

2.1 REFERENCE DOCUMENTS

Analog Devices, AD584 data sheet.

 Single Event Effects Test method and Guidelines ESA/SCC basic specification No 25100

 The Heavy Ion Irradiation Facility at CYCLONE, UCL document, Centre de Recherches du Cyclotron (IEEE NSREC'96, Workshop Record, Indian Wells, California, 1996)

3. ORGANIZATION OF ACTIVITIES

The different tasks performed during this evaluation have been conducted in the order shown in Table 1 by the relevant company.

Table 1 - Organization of activities

Para. 5.1	Procurement of Test Samples (Hi-rel serialized devices)	ESA / IGG
Para. 5.2	Preparation of Test Samples (mounting and delidding)	Hirex
Para. 5.3	Preparation of Test Hardware and Test Program	Hirex
Para. 5.4	Samples Check out	Hirex
Para. 5.5	Accelerator Test	Hirex
	Heavy Ion Test Report	Hirex



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DEVICE AND MANUFACTURER INFORMATION 4.

Description of the devices is as follows:

AD584

Part type : Manufacturer :

Analog Devices

Package:

TO99

Quality Level: Date Code:

SCC B 9624A

Serial Number:

#330, #331, #333, #334, #335

Die Technology:

Bipolar

Die Size:

2.3 mm x 1.6 mm approximately

Die Marking:

ADI

D581 1992

Tested samples:

2 (#334, #335)

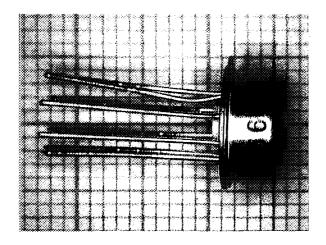
External and Internal Photos are shown in Figure 1.



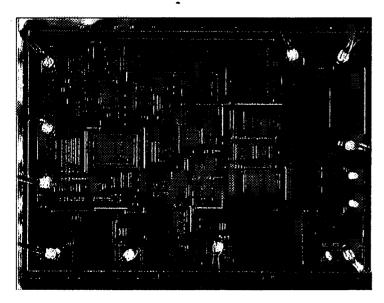
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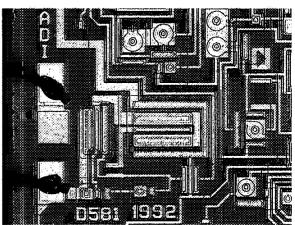
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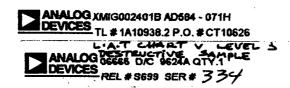
Figure 1 - External and Internal Photos













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5. TASK DESCRIPTION

5.1 PROCUREMENT OF TEST SAMPLES

5 hi-rel samples have been procured by ESA, and provided to HIREX.

5.2 PREPARATION OF SAMPLES

The 3 devices with the following serialized numbers #333, #334, #335, have been delidded by HIREX lab.

No sample has been mechanically damaged during this operation.

5.3 PREPARATION OF TEST HARDWARE AND PROGRAM

Overall device emulation, SEU and Latch-up detection, data storage and processing were implemented using an in-house test hardware and an application specific test board.

The generic in-house test equipment is driven by a PC computer through a RS232 line. All power supplies and input signals are delivered and monitored by the in-house equipment which also stores in its memory the output data from the device throughout the specific test board.

The application specific test board allowed to interface the standard test hardware with the device under test, in order to correctly emulate the relevant part, to record all the different type of errors during the irradiation and to set output signal for processing and storage by the standard test equipment.

At the end of each test run, data are transferred to the PC computer through the RS232 link for storage on hard disk or floppies.

The detailed principle of the test is described in §7, while an overall description of the inhouse test equipment and interface board is given in appendix 1.

5.4 SAMPLES CHECK OUT

A functional test sequence has been performed on delidded samples to check that devices have not been degraded by the delidding operation.

5.5 ACCELERATOR TEST

Test at the cyclotron accelerator was performed at Université de Louvain (UCL) in Louvain la neuve (Belgium) under HIREX Engineering responsibility. 2 delidded samples were irradiated, while #330 was kept as reference.



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6. <u>DESCRIPTION OF TEST FACILITIES</u>

6.1 CYCLOTRON ACCELERATOR

In collaboration with the European Space Agency (ESA), the needed equipment for single events studies using heavy ions has been built and installed on the HIF beam line in the experimental hall of Louvain-la-Neuve cyclotron.

CYCLONE is a multi particle, variable energy, cyclotron capable of accelerating protons (up to 75 MeV), alpha particles and heavy ions. For the heavy ions, the covered energy range is between 0.6 MeV/AMU and 27.5 MeV/AMU. For these ions, the maximal energy can be determined by the formula : $110 \ Q^2/M$

where Q is the ion charge state, and M is the mass in Atomic Mass Units.

The heavy ions are produced in a double stage Electron Cyclotron Resonance (ECR) source. Such a source allows to produce highly charged ions and ion "cocktails". These are composed of ions with the same or very close M/Q ratios. The cocktail ions are injected in the cyclotron, accelerated at the same time and extracted separately by a fine tuning of the magnetic field or a slight changing of the RF frequency. This method is very convenient for a quick change of ion (in a few minutes) which is equivalent to a LET variation.

7. TEST PATTERN DEFINITION FOR HEAVY ION TEST

7.1 DEVICE DESCRIPTION

Pin Programmable, Precision Voltage Reference

7.2 TEST CONFIGURATION

The precision reference is set to +5V output.

The DUT output signal is monitored with a windows analog comparator which allows for the counting of transient errors into two different amplitude ranges, small, and medium:

small

20 mV < Amplitude < 312 mV

medium

312 mV < Amplitude < 5,0 V

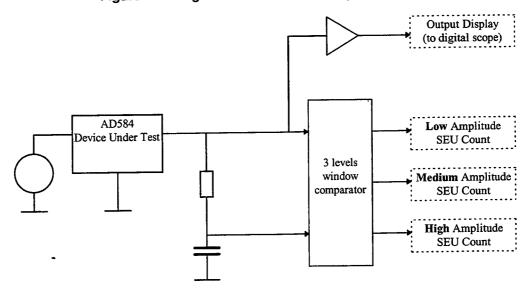
Appendix 1 gives a detailed description of the principle of this analog comparator with the rationale for the pre-defined windows thresholds.

The use of such a device allows to quantify at run time, the number of transients per amplitude range.

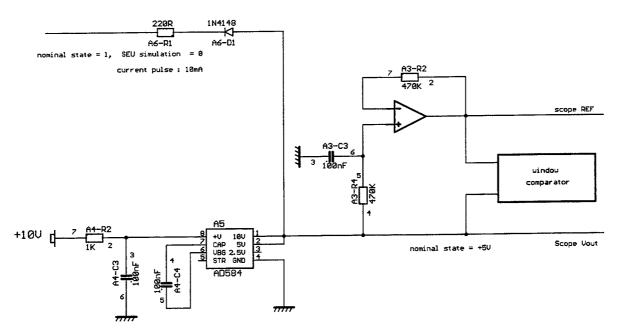
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Figure 2 - Votage Reference Test Principle



7.3 <u>DEVICE CONNECTION DIAGRAM</u>



Details on both motherboard and DUT board are provided in HRX/97.2829 document "Specific Hardware and Software Definition".



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7.4 DEVICE TEST SET UP

Appendix 1 gives a generic description of the test set-up with the meaning of the different symbols of the parameters specified here below.

Supplies

Supplies				,		T	f	
signal	module	U Reg	l max	Լա	l _{nom}	Δ	function	
3,91,01	8	+10V	20mA	not used	1mA		V+ DC follower amplifier	
V _L	 	+10V	20mA	not used	0.4mA		V+ DUT	
V _{A+}	9	±10V	ZUITA	Hot asca		+ -	not used	
ا V _A _	10						Hot doca	

Latch Up timing

Laten op tilling			
T _{wait}	Toff	T _{set up} x 3	TLU
20ms	100ms	400ms	1320ms

Clocks & commands

signal	module	period	pulse width	function
CK1	4			not used
CK2	4~			not used
СКЗ	5			not used
CK4	6	420ms	12.8µs	simulation

Event counters

signal	module	pulse min.	Hold Off	function
CT1	16	200ns	100µs	windows analog comparator SMALL absolute amplitude > 20mV
CT2	18	200ns	100µs	windows analog comparator MEDIUM absolute amplitude > 312mV
СТЗ	20	200ns	100µs	windows analog comparator LARGE absolute amplitude > 5V
CT4	22			not used

Oscilloscope monitoring @50 Ω

OSCIIIOSCO	be monitoring	@3032	····	
signal	Bandwidth	function	gain	nominal level
Vref	4Hz	DC follower amplifier output	1/8 ±1.25V ⇔ ±10V	625mV
Vout	50MHz	DUT output	1/8 ±1.25V ⇔ ±10V	625mV

Check test

output = 5V, I nom Va+ = 0.4mA
:
increment only « SMALL & MEDIUM» counter at ≈ 2Hz

Test board

Ref. : IL043-13	Dim. : 141mm x 50m	slot : DUT 2	
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8. EXPERIMENTAL TEST SET-UP

8.1 ION BEAM SELECTION

The LET range was obtained by changing the ion species and incident energy and changing the angle of incidence between the beam and the chip.

Table 2 provides the ions which were used to determine the LET threshold and the asymptotic cross section within the LET range for this heavy ion characterization. In addition this table includes the ion energy, the LET, the range and the tilt angle if any.

8.2 FLUX RANGE

Particle flux was comprised between 1. x10E3 and 4. x10E4 ions/cm²/sec under normal operations (tilt 0°).

8.3 PARTICLE FLUENCE LEVELS

Fluence level was comprised between 5 x10E4 and 5 x10E5 ions/cm² under normal operations (tilt 0°).

8.4 DOSIMETRY

The current UCL Cyclotron dosimetry system and procedures were used.

8.5 ACCUMULATED TOTAL DOSE

The equivalent total dose (rad(Si)) received by each device under test is given in Table 2.

8.6 TEST TEMPERATURE RANGE

All the tests performed were conducted at ambient temperature.

9. RESULTS

Heavy ion SEE results are given in Table 2 and plotted as SEU cross section (cm^2 /device) versus LET for the total number of errors, in Figure 3.

A strong tilt angle effect on the cross section value can be observed.

From Figure 3 a), it can be seen that LET threshold should be slightly lower than 1,7 MeV/mg/cm². Asymptotic cross-section is found to be around 1E-2 cm²/device.

Figure 3 b) shows the relative weight of the different transient errors when sorted by amplitude range. Only "small" transients (amplitude between 20 mV and 312 mV).have been observed below 14 MeV/mg/cm².

In Figure 4, typical waveforms of positive and negative events are provided as well as the envelop of events recorded for a set of representative runs.

All tested samples have received an equivalent dose (TID) below 1.0 krad.

No SEL has been detected during the different runs performed on the two samples.



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Table 2 - Heavy ions tests results

	-	—		_								_	_	7	_				_	_		-	\neg
Comments																				····			
Cumulative	dose /SN	rads(Si)	1,14E+02	5,00E+01	9,59E+02	6,86E+02	5,51E+02	4,55E+02	3,21E+02	1,80E+02	3,87E+02	2,27E+02	9,78E+02	9,92E+02	1,08E+02	4,48E+01	2,04E+02	2,76E+02	4,83E+02	3,89E+02	3,23E+02	5,02E+02	5,16E+02
Dose	/run	rads(Si)	6,35E+01	5,00E+01		1,35E+02						4,68E+01	1,92E+01	1,36E+01				7,15E+01	9,38E+01	6,66E+01	4,68E+01		1,38E+01
Cross	Section	cm²	1,23E-02	1,24E-02	7,55E-03	2,07E-03	3,09E-03	4,11E-03	3,83E-04	4,09E-04	4,36E-04	4,38E-04	1,68E-04	1,18E-04	1,10E-02	1,12E-02	2,22E-03	2,97E-03	3,87E-04	4,91E-04	4,12E-04	2,30E-04	1,64E-04
	Total		618	969	3786	622	932	1235	192	202	219	219	84	29	549	561	699	942	194	247	206	116	83
		4	<u> </u>												<u> </u>	_	_				_		_
SEU's	,) ed/	3	0	0	0	0	0	<u> </u>	0	_	0	0	_	0	0	_	_	0	_	_	_	_	
	Error type (*)	2	56	19	167	2	45	92	0	0	0	0	0	0	22	18	54	99	0	0	_	<u> </u>	٥
-	Ш	-	592	229	3619	601	887	1143	192	205	219	219	84	29	527	543	615	876	194	247	206	116	83
Fluence	<u>L</u>	p/cm²	50243	55947	501456	300008	301397	300462	501723	501027	501813	500074	500114	500190	50046	50047	301817	317071	501001	503248	500338	504771	507120
Flux	-	p/cm²/s	7,91E+02	1,12E+03	1,84E+03	2,22E+03	3,13E+03	4,43E+03	5,34E+03	7,56E+03	7,56E+03	1,07E+04	2,60E+04	3,68E+04	7,91E+02	1,12E+03	3,13E+03	4,43E+03	5,34E+03	7,56E+03	1,07E+04	2,60E+04	3,68E+04
Time		s	201	352	520				203	162	136	106	216	128	338	234	111	71	302	131	144	82	89
TET	Effective	Mev/mg/cm ²	79.05	55,90	34.00	28,20	19,94	14,10	11,70	8,27	8,27	5.85	2.40	1,70	79,05	55,90	19,94	14,10	11,70	8,27	5,85	2.40	1,70
Range	Effective	(Si) mri	30	43	43	21	30	42	23	32	32	45	27	80	30	43	30	42	23	32	45	27	80
Ē	Angle		45	0		09	45	0	09	45	45	0	45	0	45	0	45	0	09	45	0	45	0
LET		Mev/mg/cm ²	55.9	55.9	34	14.1	1.41	14.1	5.85	5.85	5,85	5.85	1.7	1.7	55.9	55,9	14,1	14.1	5.85	5,85	5,85	1.7	1,7
Energy	3	MeV	459	459	316	150	150	150	78	78	78	28	41	14	459	459	150	150	78	2.8	28/	41	41
<u>6</u>		1	×	×	, <u>7</u>	Ā	Ā	Ā	Š	Ž	Š	S	ď	60	×e	×	Ā	Ā	Š	Š	Š	<u> </u>	ω.
NS			334	334	334	334	334	334	334	334	334	334	334	334	335	335	335	335	335	335	335	335	335
Type			AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584	AD584
Bun	#		F	: 5	100	12.	120	119	107	105	108	106	175	176	73	72	88	68	3 %	91	06	179	8 2

*Error types:
1 20 mV < Transient amplitude < 312 mV
2 312 mV < Transient amplitude < 5,0 V
3 5,0 V < Transient amplitude
4 Not used



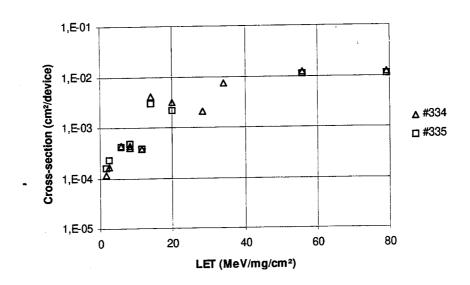
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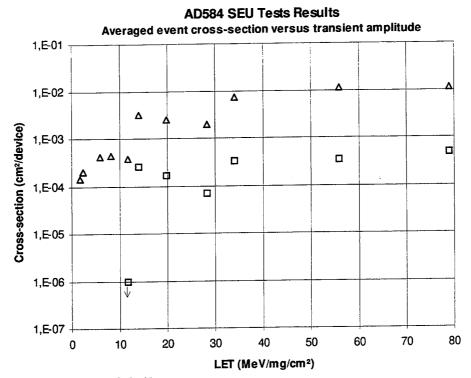
Figure 3 - AD584 SEU Test Results

a) Total SEU error number per irradiated sample

AD584 SEU Tests Results



b) Average SEU error number per transient amplitude range



 \triangle 20 mV < Amplitude < 312 mV \square 312 mV < Amplitude < 5,0 V



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10. CONCLUSION

SEU test have been conducted on AD584 Voltage Reference from Analog Devices, using the heavy ions available at the University of Louvain facility.

SEU susceptibility was obtained through the cross section versus LET curve for two different transient amplitude ranges (small and medium, respectively 20 mV-312 mV and 312 mV-5,0 V).

On Figure 4, it can be seen that negative transients of up to approximately 1,8 V and positive pulses of less than 500 mV, have been observed. However, it might not be the worst case as the waveform envelop was recorded for few runs only.

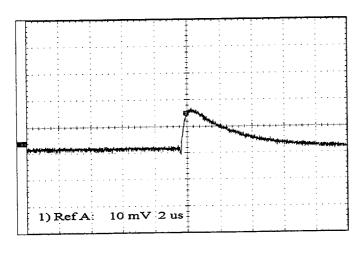
These transients may affect circuits connected to the output of the DUT. Specific analysis is recommended for XMM particular applications.

Lastly, no SEL has been detected during the different runs performed on the two samples.

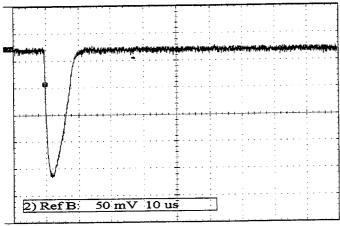


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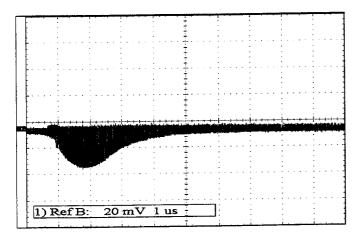
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Typical event waveform



Typical event waveform



Run 106 Envelop

(Observed signal to be multiplied by a factor of 8 to obtain the actual amplitude)

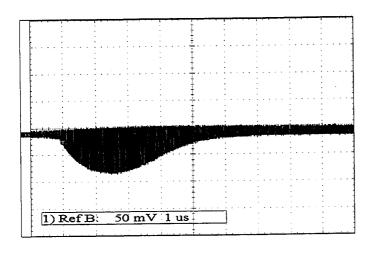
Each different run number corresponds to a given run listed in Table 2

Figure 4 Scope observation of SEUs

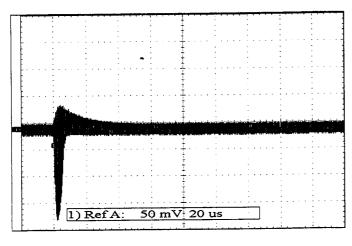


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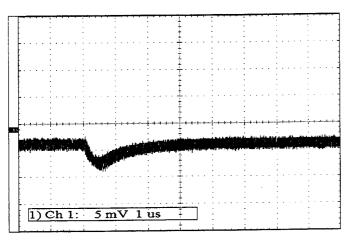
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Run 119 Envelop



Run168 Envelop



Run 175 Envelop

(Observed signal to be multiplied by a factor of 8 to obtain the actual amplitude)

Each different run number corresponds to a given run listed in Table 2

Figure 4 Scope observation of SEUs (cont'd)



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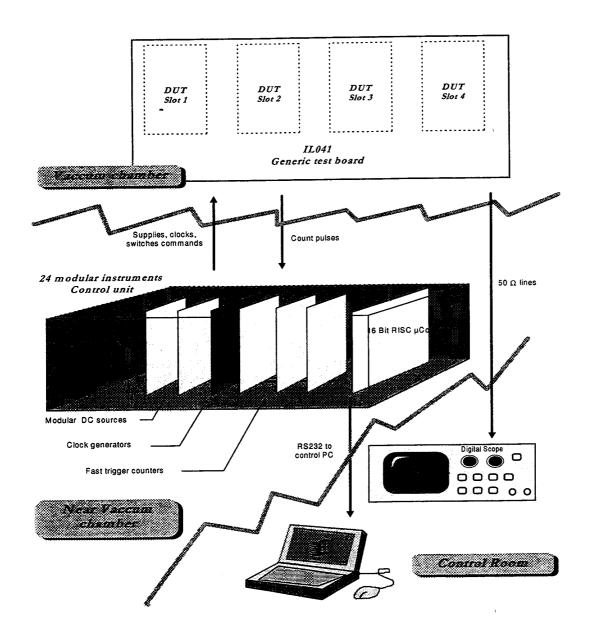
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Appendix 1

Test set-up

The complete test equipment is constituted of:

- A PC computer (to configure and interface with the test system and store the data),
- An electronic rack with the instrumentation functions provided by a set of electronic modules,
- A mother board under vacuum which allows for the sequential test of up to 4 devices
- A digital oscilloscope to store analog upset waveform.





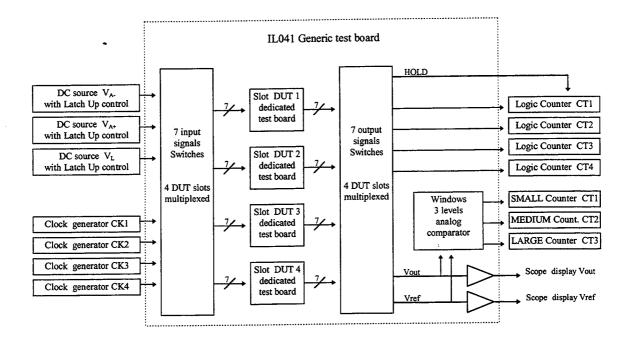
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Mother board description (ref. IL041)

The motherboard acts as a standard interface between each DUT test board and the control unit : For each DUT board slot , the following signals can be considered:

- seven inputs signals
 - 3 programmable power supplies
 - 4 programmable clocks
- seven output signals
 - 4 logic counting signals
 - 2 analog signals : DUT output and Ref . output
 - 1 HOLD signal which can inhibit temporarily the counters.
- Each device needs a dedicated plug-in test board compatible with IL041 mother board.
- IL041 board has been designed to comply with Louvain Test facilities.
- The number of slots is limited to four
 - Operation is multiplexed and only one slot is powered at one time.



DUT Test board description

The device under test is mounted on a specific board support which is plugged onto the motherboard. Mechanical outlines: 141 mm x 50 mm, wrapping or printed circuit board with two 20 pins connectors. According to test set up and device operating conditions, the test board can accept the mounting of:

- The DUT package with beam positioning constraints (unique for Louvain facilities)
- The golden chip
- The pattern generator
- any interface circuit such as buffer, latches ...
- a standalone micro controller if necessary...

Note: beam focus diameter is limited to maximum 25 mm, to prevent the exposure of others devices which might be sensitive.



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Three Windows analog comparator

Applications:

Single analog output devices, including DAC, can be monitored with a generic 3 windows fast comparator associated to 3 counter modules .

Test principle:

Each window uses pre-defined levels centered around the awaited working point:

- The SMALL window uses the lowest levels compatible with the hardware limitation (offset, noise ...)
- The LARGE window is for counting major DUT output perturbations: Vout max /2 or DAC MSB...
- The MEDIUM window has been defined using a geometric progression between SMALL and LARGE

To illustrate how it works, the here after figure gives an example of timing diagram:

Both DUT and Ref. working point can vary within the ±2.5V allowed input range (+1V in the example).

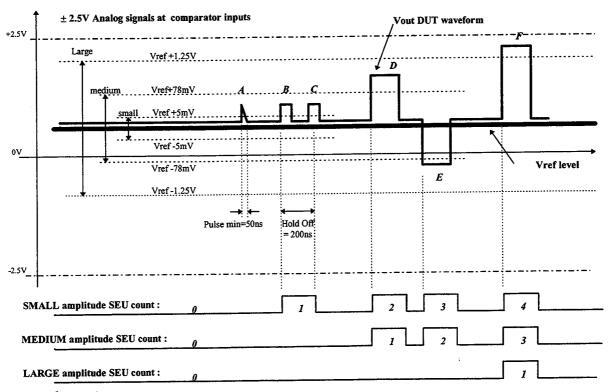
6 transient pulses can be seen on the DUT Vout record:

Pulse A will not be counted as its width is shorter than Pulse min parameter

Pulse B and C: Only B will be counted as the time between B and C is less than the Hold Off parameter (this prevents of multiple counting in case of large degraded transient)

Pulse D and E: Both pulses will be counted as the comparator works whatever polarity.

■ Pulse F is an example of large event . It can be noticed that a large event is also counted as a medium and a small as well.



Interest:

The use of this principle allows for straightforward analysis of the test data, at run time. So, it is easy to react and adjust the beam conditions to obtain proper data. When preparing the report, it also shortens the subsequent run recorded data analysis exercise.

Lastly, using 3 different levels at a time, reduces the number of runs needed for the device characterization

ADC converters:

The here above method can also be transposed to the test of ADCs. In that case, the 3 windows analog comparator is replaced by a simple standalone micro controller witch execute the same windowing operation by soft.



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Working point variation and HOLD function:

This window comparison is compatible with low frequency working point variation (few Hertz) . This is particularly useful with ADC and DAC devices : Saw tooth input pattern can be used to test the device with a uniform digital code distribution. In that case, the input saw tooth is rather a stair case signal. HOLD function allows to inhibit comparison and counting each time the pattern changes.

Test signals definition

Sunnlies

_	signal	module	U Reg	l _{max}	l Lu	I nom	IΔ	function
	VL	8						
Г	V _{A+}	^ 9						
	٧۵.	10						

- signals V_L , V_{A+} & V_{A-} are 3 DC sources with constant voltage / current characteristic, software monitoring, Latch Up threshold detection, delayed start & stop triggering
- module: Slot position used by hardware & software control system
- U Reg: DC source set up for constant voltage operation
- I max: DC source set up for constant current operation, useful on large DUT latch up or failure
- I Lu: software Latch Up detection current threshold
- I nom: nominal current when DUT operates properly
- \mathbf{I}_{Δ} : minimum current measurement change required for event memory write
- function: DC source assignment (DUT or test board auxiliary device)

Latch Un timing

Laten op tilli	iig		
Twait	Toff	T set up x 3	TLU

Twait

Sustaining Latch Up time (delay between detection and DC sources shut down)

Toff

Off state duration

- T set up x 3 Restart triggering Delay between the different internal sequential levels
- TLU

Total latch Up sequence duration

clocks & commands

signal	module	period	pulse width	function
CK1	4			
CK2	4			
СКЗ	5			
CK4	6			
HOLD				

- CK 1, CK2, CK3, CK 4 are 4 dedicated programmable logic signals (static or dynamic) which can be used for DUT Clock, DUT mode selection, Upset simulation ...
- HOLD is a dedicated signal generated by the test board circuitry; HOLD = 1 disable all the event counters when the analog comparison is not available, during DUT level transitions ...



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Event counters

signal module Pulse min.		Hold Off	function				
CT1	16			SMALL or Logic event 1			
CT2	18			MEDIUM or Logic event 2			
CT3	20			LARGE or Logic event 3			
CT4	22			Logic event 4			

- signals CT1 ... CT4 are 4 count input channels, either for straightforward logic event acquisition or for window analog comparator acquisition
- Pulse min: minimum pulse width required, according to overall system bandwidth
- Hold Off: minimum delay imposed between the detection of two consecutive events

oscilloscope monitoring @50 Ω

signal	Bandwidth	function	gain	nominal level
Vref				
Vout				A 12 24 1 -

- signals Vref and Vout are the 2 analog input channels for both analog comparator and digital scope
- Bandwidth: overall channel bandwidth
- gain: channel gain between actual DUT level and scope displayed level

Note: The oscilloscope can be triggered by one of the event counter input signal CT1 ... CT4

Check test

CHECK IESI	
nominal state check	
upset detection check	

To check that the device is operating properly, this test can be perform at any time under software control. The use of CK4 signal allows for two different modes :

- nominal state check : CK4 disable , absence of any event
- upset detection check: CK4 enable, presence of calibrated simulated event periodically introduced at a slow rate

Tes	t b	oard	

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Ref. : IL043-xx	Dim. :	slot :	<u> </u>	 	 	
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Each set up is dedicated to a specific slot number, in order to ensure that each device is tested with the proper set up conditions.